



SCCS028B - December 1987 - Revised September 2001

# CY74FCT16244T CY74FCT162244T CY74FCT162H244T

## 16-Bit Buffers/Line Drivers

### Features

- $I_{off}$  supports partial-power-down mode operation
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- $V_{CC} = 5V \pm 10\%$

#### CY74FCT16244T Features:

- 64 mA sink current, 32 mA source current
- Typical  $V_{OLP}$  (ground bounce) < 1.0V at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}\text{C}$

#### CY74FCT162244T Features:

- Balanced output drivers: 24 mA
- Reduced system switching noise
- Typical  $V_{OLP}$  (ground bounce) < 0.6V at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}\text{C}$

#### CY74FCT162H244T Features:

- Bus hold on data inputs
- Eliminates the need for external pull-up or pull-down resistors

### Functional Description

These 16-bit buffers/line drivers are designed for use in memory driver, clock driver, or other bus interface applications, where high-speed and low power are required. With flow-through pinout and small shrink packaging board layout is simplified. The three-state controls are designed to allow 4-bit, 8-bit or combined 16-bit operation.

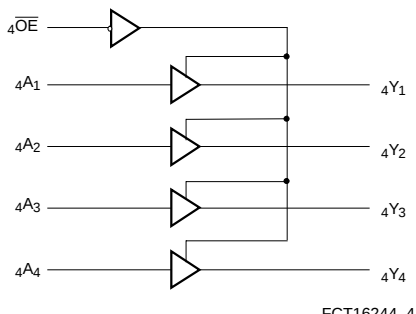
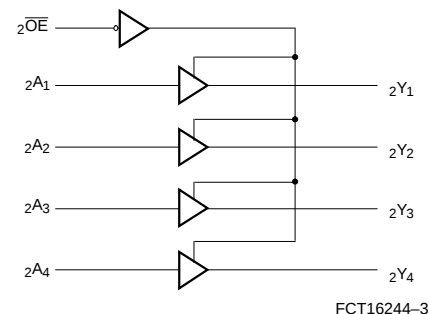
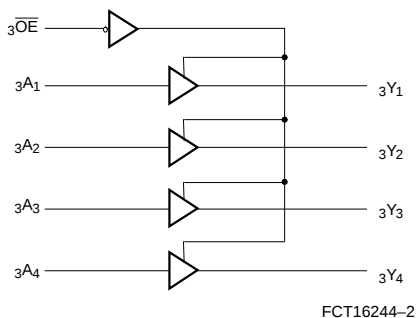
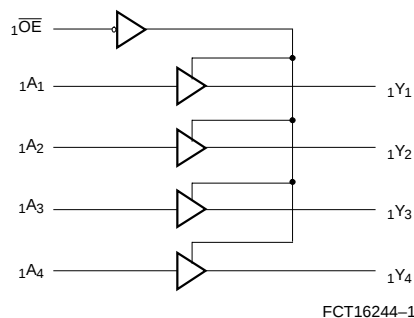
This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The CY74FCT16244T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162244T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162244T is ideal for driving transmission lines.

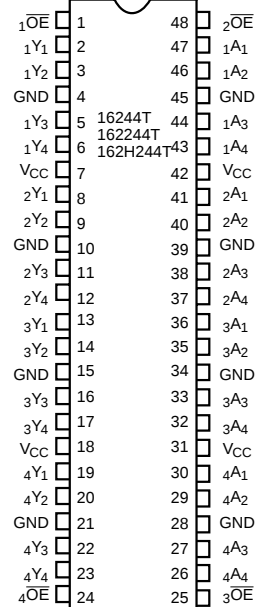
The CY74FCT162H244T is a 24-mA balanced output part that has "bus hold" on the data inputs. The device retains the input's last state whenever the input goes to high impedance. This eliminates the need for pull-up/down resistors and prevents floating inputs.

### Logic Block Diagrams CY74FCT16244T, CY74FCT162244T, CY74FCT162H244T



### Pin Configuration

#### SSOP/TSSOP Top View



## Pin Description

| Name            | Description                                   |
|-----------------|-----------------------------------------------|
| $\overline{OE}$ | Three-State Output Enable Inputs (Active LOW) |
| A               | Data Inputs <sup>[1]</sup>                    |
| Y               | Three-State Outputs                           |

## Function Table<sup>[2]</sup>

| Inputs          |   | Outputs |
|-----------------|---|---------|
| $\overline{OE}$ | A | Y       |
| L               | L | L       |
| L               | H | H       |
| H               | X | Z       |

## Maximum Ratings <sup>[3,4]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature..... –55°C to +125°C

Ambient Temperature with

Power Applied..... –55°C to +125°C

DC Input Voltage ..... –0.5V to +7.0V

DC Output Voltage..... –0.5V to +7.0V

DC Output Current

(Maximum Sink Current/Pin) ..... –60 to +120 mA

Power Dissipation ..... 1.0W

Static Discharge Voltage..... >2001V  
(per MIL-STD-883, Method 3015)

## Ordering Range

| Range      | Ambient Temperature | V <sub>CC</sub> |
|------------|---------------------|-----------------|
| Industrial | – 40°C to +85°C     | 5V ± 10%        |

### Notes:

1. On CY74FCT162H244T these pins have "bus hold."
2. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = High Impedance.
3. Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.
4. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V<sub>CC</sub> or ground.

## Electrical Characteristics Over the Operating Range

| Parameter                              | Description                                                 |          | Test Conditions                                            | Min. | Typ. <sup>[5]</sup> | Max. | Unit |
|----------------------------------------|-------------------------------------------------------------|----------|------------------------------------------------------------|------|---------------------|------|------|
| V <sub>IH</sub>                        | Input HIGH Voltage                                          |          |                                                            | 2.0  |                     |      | V    |
| V <sub>IL</sub>                        | Input LOW Voltage                                           |          |                                                            |      |                     | 0.8  | V    |
| V <sub>H</sub>                         | Input Hysteresis <sup>[6]</sup>                             |          |                                                            |      | 100                 |      | mV   |
| V <sub>IK</sub>                        | Input Clamp Diode Voltage                                   |          | V <sub>CC</sub> =Min., I <sub>IN</sub> =–18 mA             |      | –0.7                | –1.2 | V    |
| I <sub>IH</sub>                        | Input HIGH Current                                          | Standard | V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>CC</sub>     |      |                     | ±1   | μA   |
|                                        |                                                             | Bus Hold |                                                            |      |                     | ±100 |      |
| I <sub>IL</sub>                        | Input LOW Current                                           | Standard | V <sub>CC</sub> =Max., V <sub>I</sub> =GND                 |      |                     | ±1   | μA   |
|                                        |                                                             | Bus Hold |                                                            |      |                     | ±100 |      |
| I <sub>BBH</sub><br>I <sub>BBL</sub>   | Bus Hold Sustain Current on Bus Hold Input <sup>[7]</sup>   |          | V <sub>CC</sub> =Min., V <sub>I</sub> =2.0V                | –50  |                     |      | μA   |
|                                        |                                                             |          | V <sub>I</sub> =0.8V                                       | +50  |                     |      |      |
| I <sub>BHHO</sub><br>I <sub>BHLO</sub> | Bus Hold Overdrive Current on Bus Hold Input <sup>[7]</sup> |          | V <sub>CC</sub> =Max., V <sub>I</sub> =1.5V                |      |                     | TBD  | mA   |
| I <sub>OZH</sub>                       | High Impedance Output Current (Three-State Output pins)     |          | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.7V              |      |                     | ±1   | μA   |
| I <sub>OZL</sub>                       | High Impedance Output Current (Three-State Output pins)     |          | V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.5V              |      |                     | ±1   | μA   |
| I <sub>OS</sub>                        | Short Circuit Current <sup>[8]</sup>                        |          | V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND               | –80  | –140                | –200 | mA   |
| I <sub>O</sub>                         | Output Drive Current <sup>[8]</sup>                         |          | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.5V              | –50  |                     | –180 | mA   |
| I <sub>OFF</sub>                       | Power-Off Disable                                           |          | V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.5V <sup>[9]</sup> |      |                     | ±1   | μA   |

**Output Drive Characteristics for CY74FCT16244T**

| Parameter       | Description         | Test Conditions                                | Min. | Typ. <sup>[5]</sup> | Max. | Unit |
|-----------------|---------------------|------------------------------------------------|------|---------------------|------|------|
| V <sub>OH</sub> | Output HIGH Voltage | V <sub>CC</sub> =Min., I <sub>OH</sub> =-3 mA  | 2.5  | 3.5                 |      | V    |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =-15 mA | 2.4  | 3.5                 |      | V    |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA | 2.0  | 3.0                 |      | V    |
| V <sub>OL</sub> | Output LOW Voltage  | V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA  |      | 0.2                 | 0.55 | V    |

**Output Drive Characteristics for CY74FCT162244T, CY74FCT162H244T**

| Parameter        | Description                        | Test Conditions                                                                                   | Min. | Typ. <sup>[5]</sup> | Max. | Unit |
|------------------|------------------------------------|---------------------------------------------------------------------------------------------------|------|---------------------|------|------|
| I <sub>ODL</sub> | Output LOW Current <sup>[8]</sup>  | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | 60   | 115                 | 150  | mA   |
| I <sub>ODH</sub> | Output HIGH Current <sup>[8]</sup> | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | -60  | -115                | -150 | mA   |
| V <sub>OH</sub>  | Output HIGH Voltage                | V <sub>CC</sub> =Min., I <sub>OH</sub> =-24 mA                                                    | 2.4  | 3.3                 |      | V    |
| V <sub>OL</sub>  | Output LOW Voltage                 | V <sub>CC</sub> =Min., I <sub>OL</sub> =24 mA                                                     |      | 0.3                 | 0.55 | V    |

**Notes:**

5. Typical values are at V<sub>CC</sub>=5.0V, T<sub>A</sub> = +25°C ambient.
6. This parameter is specified but not tested.
7. Pins with bus hold are described in Pin Description.
8. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.
9. Tested at +25°C.

**Capacitance**<sup>[6]</sup> ( $T_A = +25^\circ\text{C}$ ,  $f = 1.0\text{ MHz}$ )

| Parameter | Description        | Test Conditions | Typ. <sup>[5]</sup> | Max. | Unit |
|-----------|--------------------|-----------------|---------------------|------|------|
| $C_{IN}$  | Input Capacitance  | $V_{IN} = 0V$   | 4.5                 | 6.0  | pF   |
| $C_{OUT}$ | Output Capacitance | $V_{OUT} = 0V$  | 5.5                 | 8.0  | pF   |

## Power Supply Characteristics

| Parameter       | Description                                      | Test Conditions                                                                                                                                          | Typ. <sup>[5]</sup> | Max.                 | Unit                     |
|-----------------|--------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|----------------------|--------------------------|
| $I_{CC}$        | Quiescent Power Supply Current                   | $V_{CC} = \text{Max.}$<br>$V_{IN} \leq 0.2V$ ,<br>$V_{IN} \leq V_{CC} - 0.2V$                                                                            | 5                   | 500                  | $\mu\text{A}$            |
| $\Delta I_{CC}$ | Quiescent Power Supply Current (TTL inputs HIGH) | $V_{CC} = \text{Max.}$<br>$V_{IN} = 3.4V^{[10]}$                                                                                                         | 0.5                 | 1.5                  | mA                       |
| $I_{CCD}$       | Dynamic Power Supply Current <sup>[11]</sup>     | $V_{CC} = \text{Max.}$ , One Input Toggling, 50% Duty Cycle, Outputs Open, $OE = GND$<br>$V_{IN} = V_{CC}$ or $V_{IN} = GND$                             | 60                  | 100                  | $\mu\text{A}/\text{MHz}$ |
| $I_C$           | Total Power Supply Current <sup>[12]</sup>       | $V_{CC} = \text{Max.}$ , $f_1 = 10\text{ MHz}$ , 50% Duty Cycle, Outputs Open, One Bit Toggling, $OE = GND$<br>$V_{IN} = V_{CC}$ or $V_{IN} = GND$       | 0.6                 | 1.5                  | mA                       |
|                 |                                                  | $V_{IN} = 3.4V$ or $V_{IN} = GND$                                                                                                                        | 0.9                 | 2.3                  | mA                       |
|                 |                                                  | $V_{CC} = \text{Max.}$ , $f_1 = 2.5\text{ MHz}$ , 50% Duty Cycle, Outputs Open, Sixteen Bits Toggling, $OE = GND$<br>$V_{IN} = V_{CC}$ or $V_{IN} = GND$ | 2.4                 | 4.5 <sup>[13]</sup>  | mA                       |
|                 |                                                  | $V_{IN} = 3.4V$ or $V_{IN} = GND$                                                                                                                        | 6.4                 | 16.5 <sup>[13]</sup> | mA                       |

### Notes:

10. Per TTL driven input ( $V_{IN} = 3.4V$ ); all other inputs at  $V_{CC}$  or GND.
11. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
12.  $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_0/2 + f_1 N_1)$   
 $I_C$  = Total Power Supply Current  
 $I_{CC}$  = Quiescent Current with CMOS input levels  
 $\Delta I_{CC}$  = Power Supply Current for a TTL HIGH input ( $V_{IN} = 3.4V$ )  
 $D_H$  = Duty Cycle for TTL inputs HIGH  
 $N_T$  = Number of TTL inputs at  $D_H$   
 $I_{CCD}$  = Dynamic Current caused by an input transition pair (HLH or LHL)  
 $f_0$  = Clock frequency for registered devices, otherwise zero  
 $f_1$  = Input signal frequency  
 $N_1$  = Number of inputs changing at  $f_1$   
 All currents are in milliamps and all frequencies are in megahertz.
13. Values for these conditions are examples of the  $I_{CC}$  formula. These limits are specified but not tested.

**Switching Characteristics** Over the Operating Range<sup>[14]</sup>

| Parameter                            | Description                      | CY74FCT16244T<br>CY74FCT162244T |      | CY74FCT16244AT<br>CY74FCT162244AT<br>CY74FCT162H244AT |      | Unit | Fig. No. <sup>[15]</sup> |
|--------------------------------------|----------------------------------|---------------------------------|------|-------------------------------------------------------|------|------|--------------------------|
|                                      |                                  | Min.                            | Max. | Min.                                                  | Max. |      |                          |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay Data to Output | 1.5                             | 6.5  | 1.5                                                   | 4.8  | ns   | 1, 3                     |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Output Enable Time               | 1.5                             | 8.0  | 1.5                                                   | 6.2  | ns   | 1, 7, 8                  |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time              | 1.5                             | 7.0  | 1.5                                                   | 5.6  | ns   | 1, 7, 8                  |
| t <sub>SK(O)</sub>                   | Output Skew <sup>[16]</sup>      |                                 | 0.5  |                                                       | 0.5  | ns   | —                        |

**Switching Characteristics** Over the Operating Range<sup>[14]</sup> (continued)

| Parameter                            | Description                      | CY74FCT16244CT<br>CY74FCT162244CT<br>CY74FCT162H244CT |      | Unit | Fig. No. <sup>[15]</sup> |
|--------------------------------------|----------------------------------|-------------------------------------------------------|------|------|--------------------------|
|                                      |                                  | Min.                                                  | Max. |      |                          |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay Data to Output | 1.5                                                   | 4.1  | ns   | 1, 3                     |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Output Enable Time               | 1.5                                                   | 5.8  | ns   | 1, 7, 8                  |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time              | 1.5                                                   | 5.2  | ns   | 1, 7, 8                  |
| t <sub>SK(O)</sub>                   | Output Skew <sup>[16]</sup>      |                                                       | 0.5  | ns   | —                        |

**Notes:**

14. Minimum limits are specified but not tested on Propagation Delays.

15. See "Parameter Measurement Information" in the General Information section.

16. Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.

**Ordering Information CY74FCT16244**

| Speed (ns) | Ordering Code          | Package Name | Package Type            | Operating Range |
|------------|------------------------|--------------|-------------------------|-----------------|
| 4.1        | CY74FCT16244CTPACT     | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT16244CTPVC/PVCT | O48          | 48-Lead (300-Mil) SSOP  |                 |
| 4.8        | CY74FCT16244ATPACT     | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT16244ATPVC/PVCT | O48          | 48-Lead (300-Mil) SSOP  |                 |
| 6.5        | CY74FCT16244TPACT      | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT16244TPVC/PVCT  | O48          | 48-Lead (300-Mil) SSOP  |                 |

**Ordering Information CY74FCT162244**

| Speed (ns) | Ordering Code          | Package Name | Package Type            | Operating Range |
|------------|------------------------|--------------|-------------------------|-----------------|
| 4.1        | 74FCT162244CTPACT      | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT162244CTPVC     | O48          | 48-Lead (300-Mil) SSOP  |                 |
|            | 74FCT162244CTPVCT      | O48          | 48-Lead (300-Mil) SSOP  |                 |
| 4.8        | 74FCT162244ATPACT      | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT162244ATPVC     | O48          | 48-Lead (300-Mil) SSOP  |                 |
|            | 74FCT162244ATPVCT      | O48          | 48-Lead (300-Mil) SSOP  |                 |
| 6.5        | CY74FCT162244TPACT     | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT162244TPVC/PVCT | O48          | 48-Lead (300-Mil) SSOP  |                 |

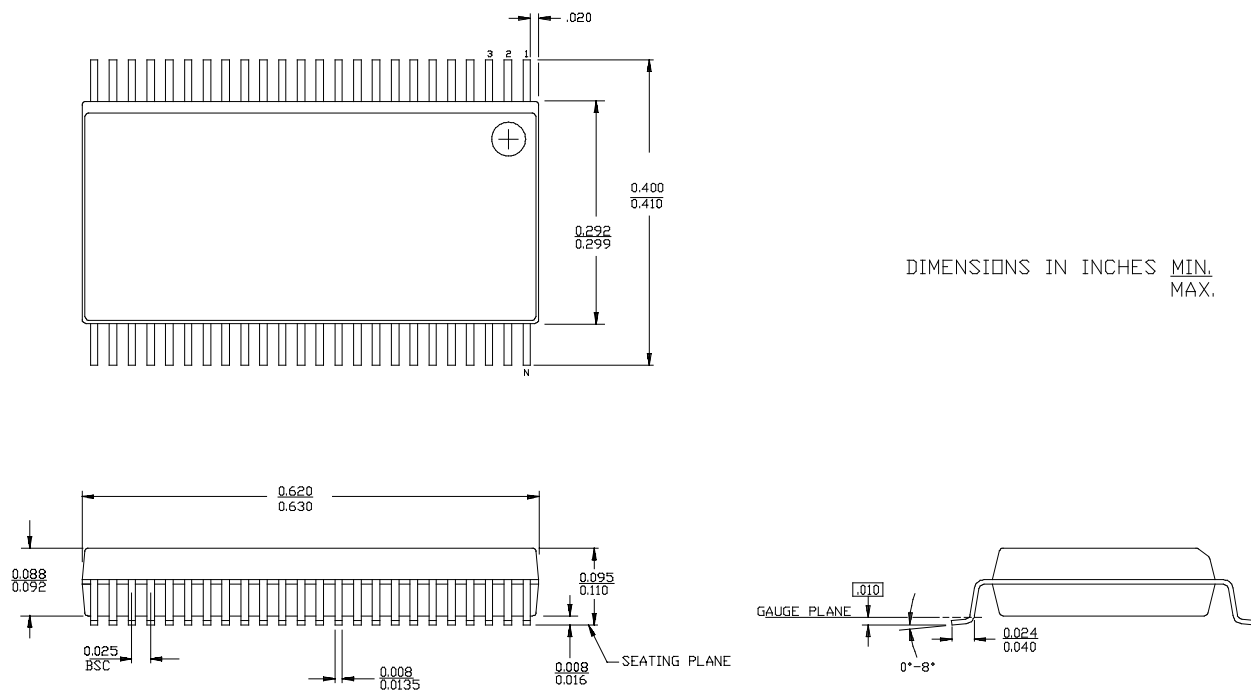
**Ordering Information CY74FCT162H244**

| Speed (ns) | Ordering Code          | Package Name | Package Type            | Operating Range |
|------------|------------------------|--------------|-------------------------|-----------------|
| 4.1        | 74FCT162H244CTPVC/PVCT | O48          | 48-Lead (300-Mil) SSOP  | Industrial      |
| 4.8        | 74FCT162H244ATPACT     | Z48          | 48-Lead (240-Mil) TSSOP | Industrial      |

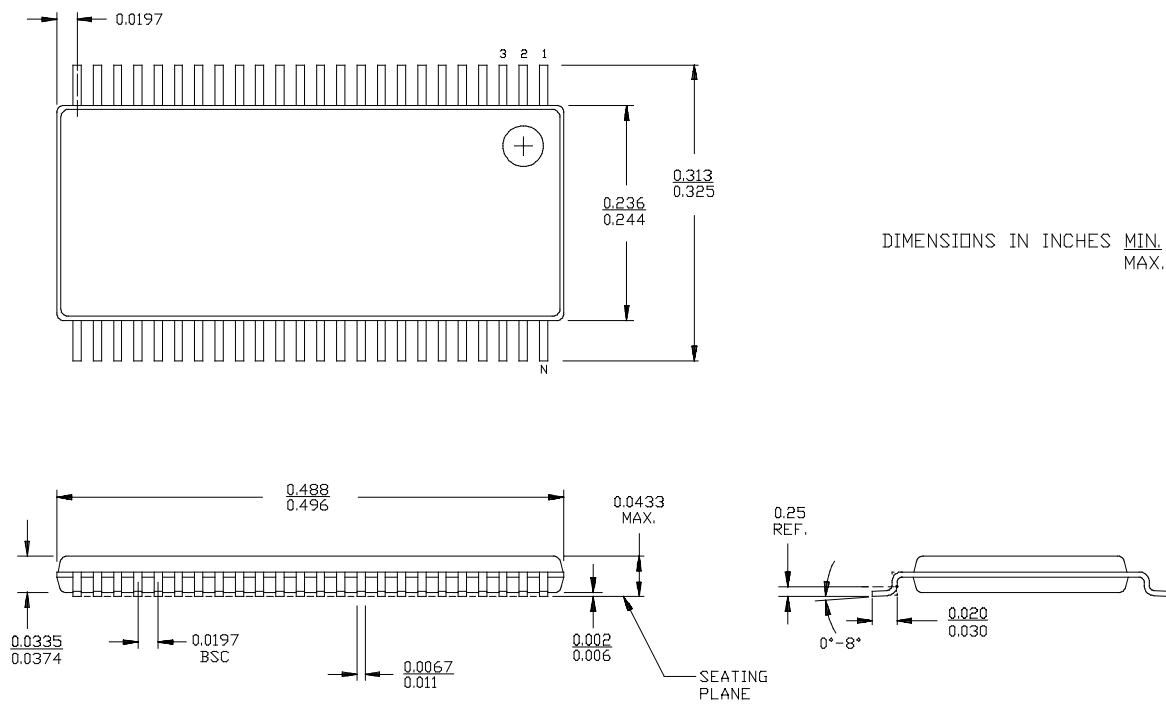
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## Package Diagrams

**48-Lead Shrunk Small Outline Package O48**



**48-Lead Thin Shrunk Small Outline Package Z48**



## PACKAGING INFORMATION

| Orderable Device   | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|--------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| 74FCT162244ATPACT  | OBSOLETE      | TSSOP        | DGG                | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT162244A              |         |
| 74FCT162244ATPVCT  | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT162244A              |         |
| 74FCT162244CTPACT  | OBSOLETE      | TSSOP        | DGG                | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT162244C              |         |
| CY74FCT162244CTPVC | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT162244C              |         |
| CY74FCT162244TPVC  | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT162244               |         |
| CY74FCT162244TPVCT | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT162244               |         |
| CY74FCT16244ATPACT | OBSOLETE      | TSSOP        | DGG                | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT16244A               |         |
| CY74FCT16244CTPACT | OBSOLETE      | TSSOP        | DGG                | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT16244C               |         |
| CY74FCT16244CTPVC  | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT16244C               |         |
| CY74FCT16244TPACT  | OBSOLETE      | TSSOP        | DGG                | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT16244                |         |
| CY74FCT16244TPVC   | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT16244                |         |
| CY74FCT16244TPVCT  | OBSOLETE      | SSOP         | DL                 | 48   |                | TBD             | Call TI                              | Call TI              | -40 to 85    | FCT16244                |         |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

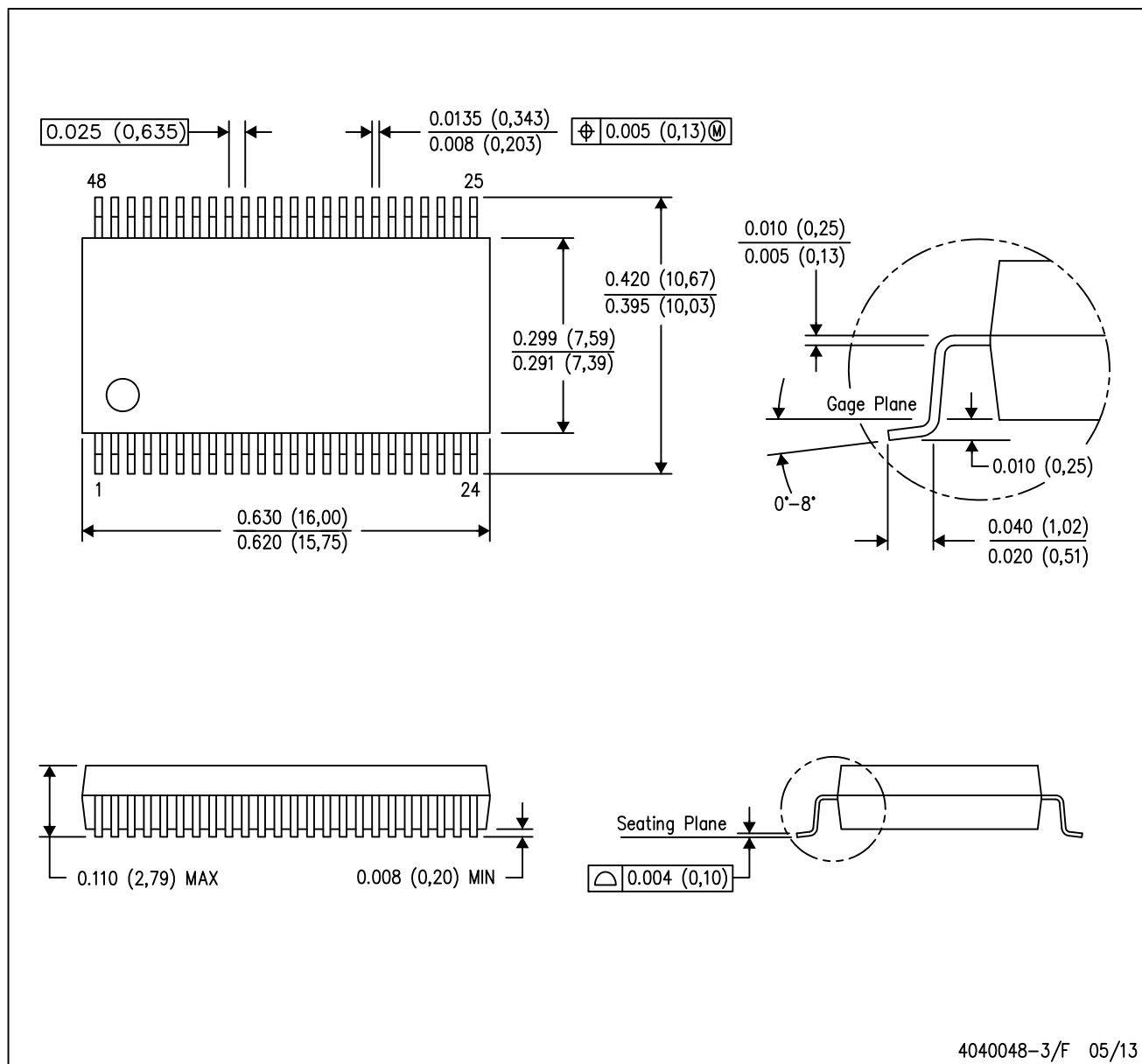
<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MO-118



4214859/B 11/2020

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

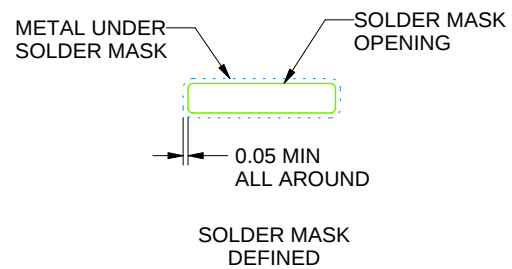
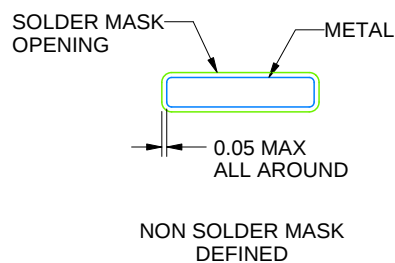
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

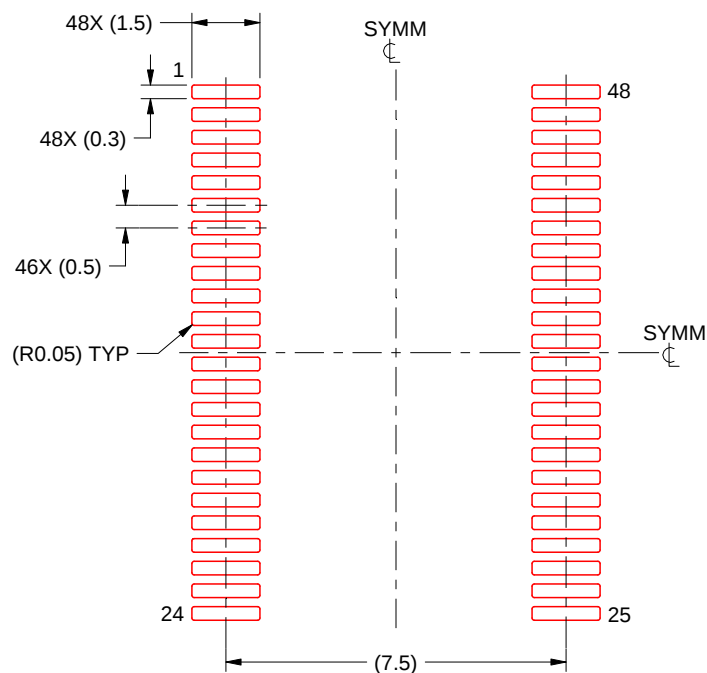
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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